

**SPI-315-34**

Ultraminiature photoreflector (single-transistor type)

Features

- Infrared LED plus Phototransistor (single)
- DIP type
- Compact type : 3.4 (L) × 2.7 (W) × 1.5 (H) mm
- Visible light cut type
- Lead length : (L=3.5mm)

Absolute Maximum Ratings at Ta=25°C, 65%RH

Parameter		Symbol	Rating	Unit
Input LED	Forward Current	I_F	50	mA
	Reverse Voltage	V_R	5	V
	Power Dissipation	P_D	70	mW
Output Phototransistor	Collector-Emitter Voltage	V_{CEO}	20	V
	Emitter-Collector Voltage	V_{ECO}	5	V
	Collector Current	I_C	20	mA
	Power Dissipation	P_C	70	mW
Operating Temperature		T_{opr}	-20 to +80	°C
Storage Temperature		T_{stg}	-30 to +100	°C
Soldering Temperature *1		T_{sol}	260	°C

*1 Soldering conditions : time : max. 3sec; clearance : min. 1mm from lower case edge.

Electro-Optical Characteristics at Ta=25°C, 65%RH

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V_F	$I_F=10\text{mA}$	1.0	1.2	1.6	V
	Reverse Current	I_R	$V_R=5\text{V}$	-	-	10	μA
Output	Dark Current	I_{CEO}	$I_F=0\text{mA}, V_{CE}=10\text{V}$	-	-	200	nA
Coupled	Collector Output Current	I_C	$I_F=10\text{mA}, V_{CE}=5\text{V}^{*1}$	80	-	1100	μA
	Leakage Current	I_{LEAK}	$I_F=10\text{mA}, V_{CE}=5\text{V}^{*2}$	-	-	1	μA
	Collector Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F=10\text{mA}, I_C=50\mu\text{A}$	-	-	0.5	V
	Rise Time	t_r	$V_{CC}=5\text{V}, R_L=100\Omega$	-	5	-	μs
	Fall Time	t_f	$I_C=1\text{mA}$	-	5	-	μs

*1 Location of reflector is shown in Fig. 1.

*2 No reflector

*3 Table of Classification of Collector Output

Class	A	B	C	D
I_C (μA)	1100 to 450	600 to 260	350 to 150	200 to 80

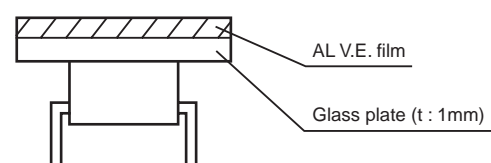


Fig. 1 Location of Reflector

Package dimensions and Pin connection

As stated in the attached paper. (No.6028 4/6)

Lot marking

Color division shall be done as shown in the drawing. (Fig. 2)

Year of even number : Front side

Year of odd number : Back side

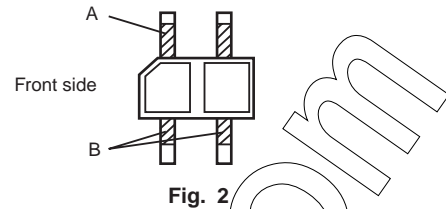


Fig. 2

Color	Black	Blue	Red	Green	Orange	Brown
Part 'A'	January	February	March	April	May	June
Part 'B'	July	August	September	October	November	December

Soldering conditions

- (1) Temperature : Max. 260°C
- (2) Time : Max. 3sec
- (3) Clearance : Min. 1mm from the case edge. (Fig. 3)

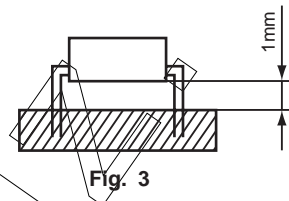
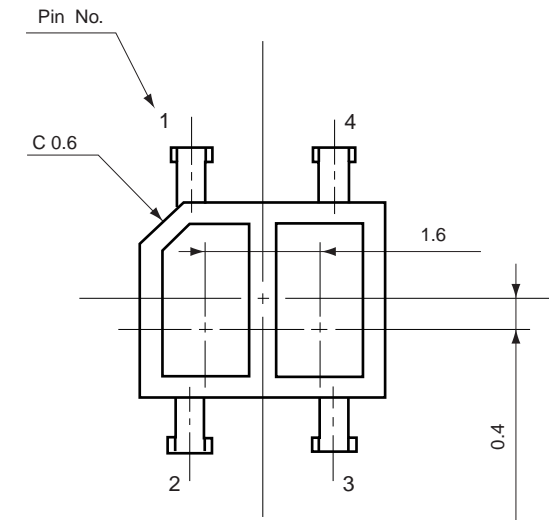


Fig. 3

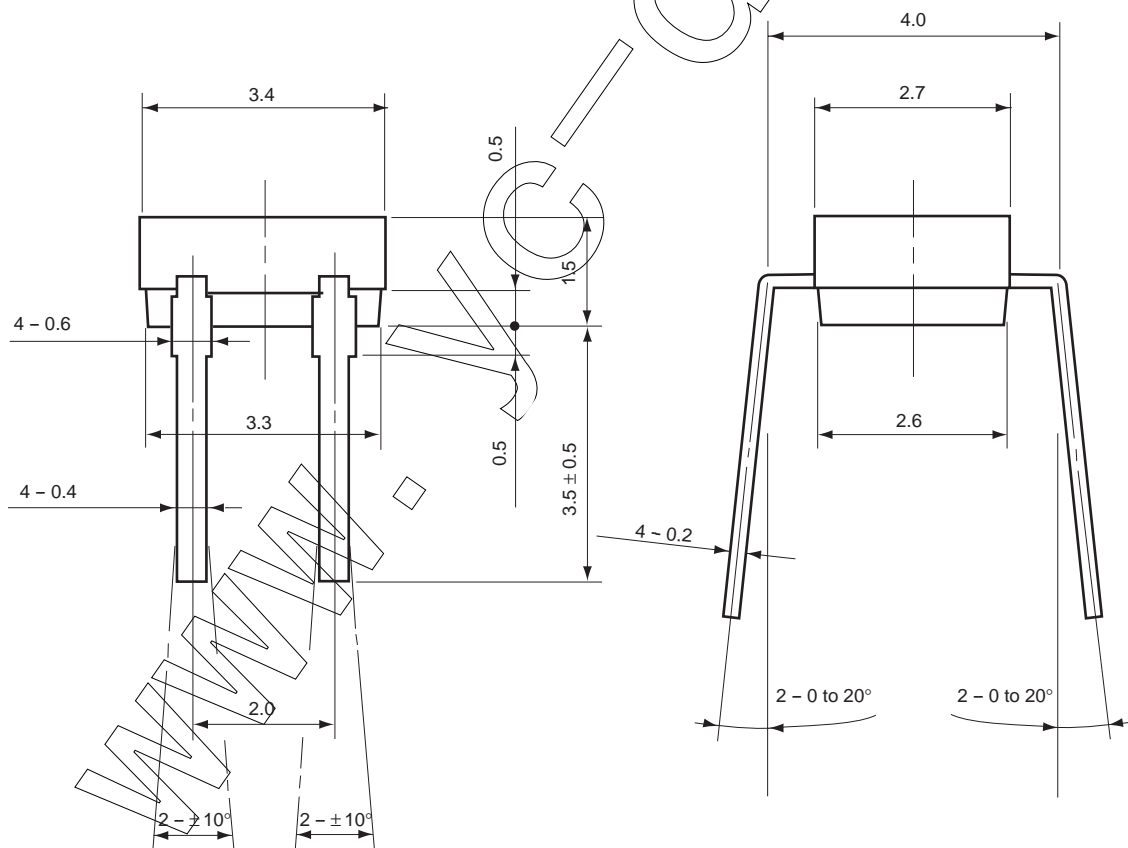
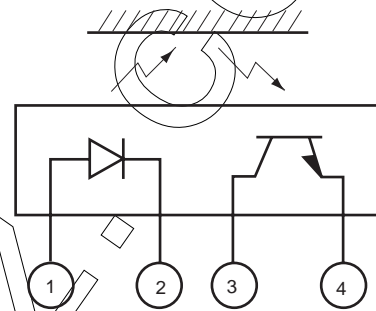
⚠ PRECAUTIONS

- (1) Bending a lead should avoid. However, when bending is necessary, take care the next items.
 - ① Bending a lead must be done before soldering.
 - ② Bending a lead must be done in the states of fixing leads and no stress for the resin part. Because it is possible that stress for the resin part cause troubles such as gold wire breaking and so on.
 - ③ A lead must be bend at intervals of 1mm from the case edge.
 - ④ Do not bend the same position of leads more than twice.
- (2) The hole pitch of a circuit board must fit to the lead pitch.
- (3) Take care the following when soldering.
 - ① Do not heat a product under any stress (a twist and so on) to leads.
 - ② Do not heat a product in the states of operating force to the resin part.
- (4) Use the flux which contain no chlorine, have no corrosion and do not need washing.
- (5) Be careful that flux or other chemicals do not attach to the luminous surface and passive surface.



Pin connection

1. LED Anode
2. LED Cathode
3. Ph. Tr Collector
4. Ph. Tr Emitter

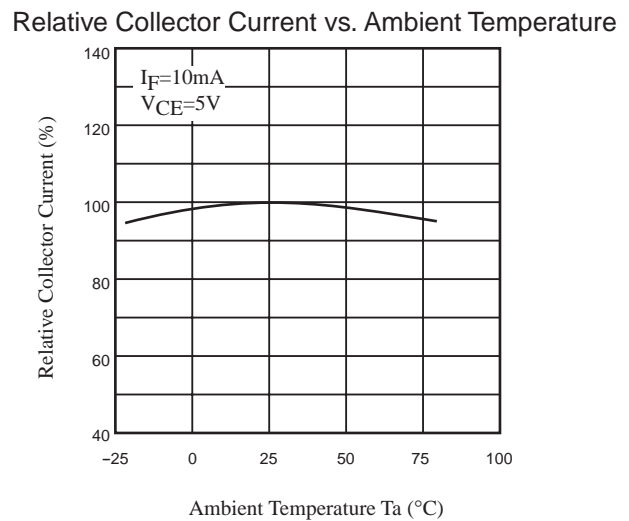
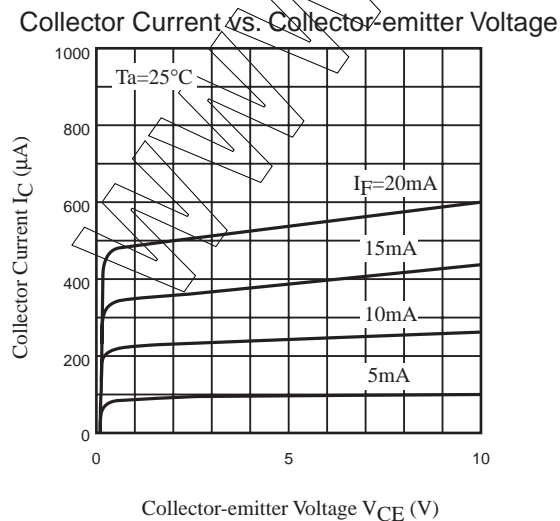
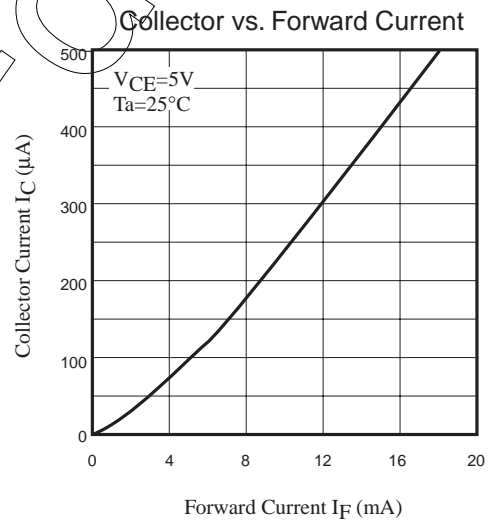
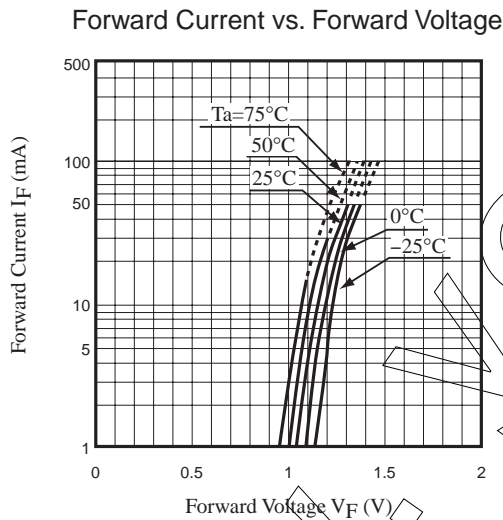
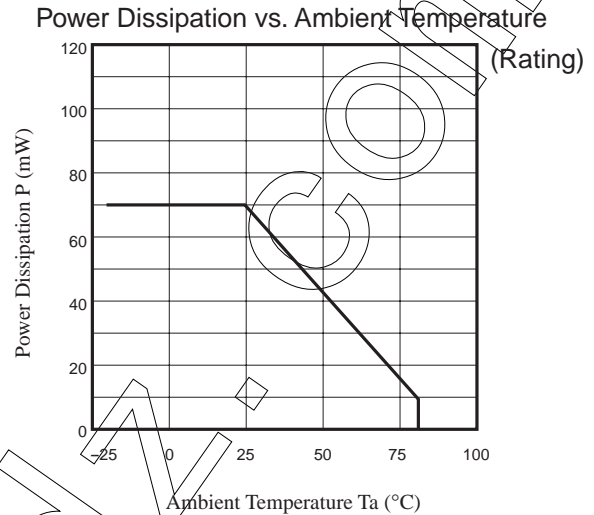
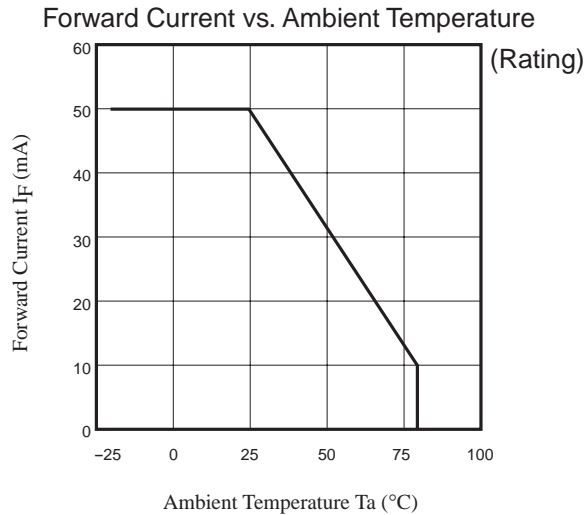


Tolerance : ± 0.2
Unit : mm

Typical Characteristics



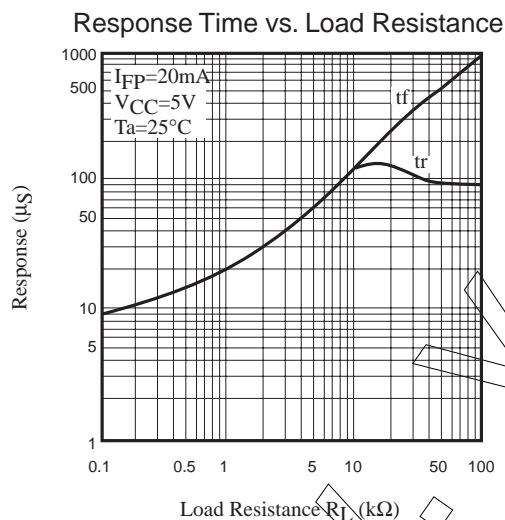
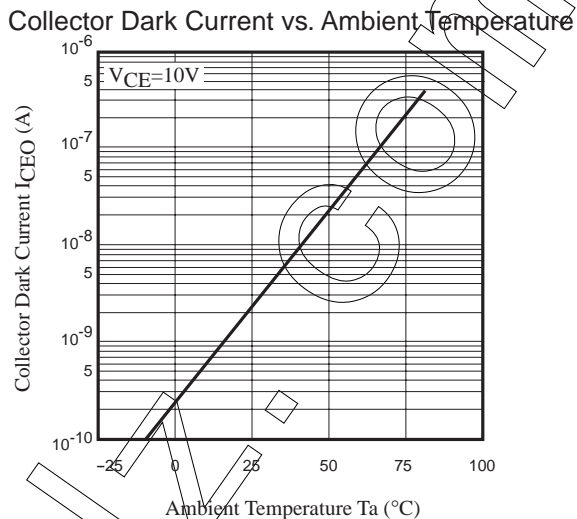
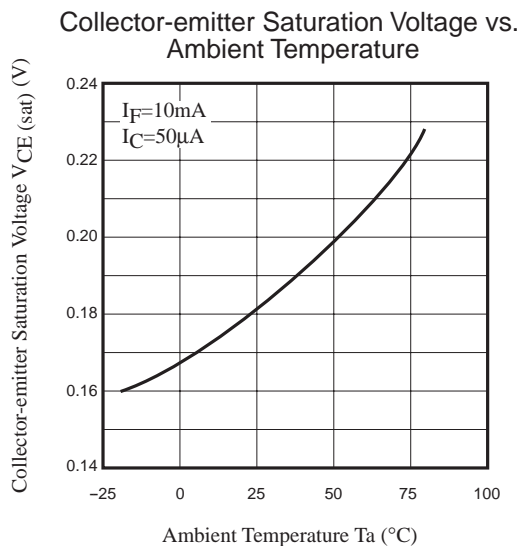
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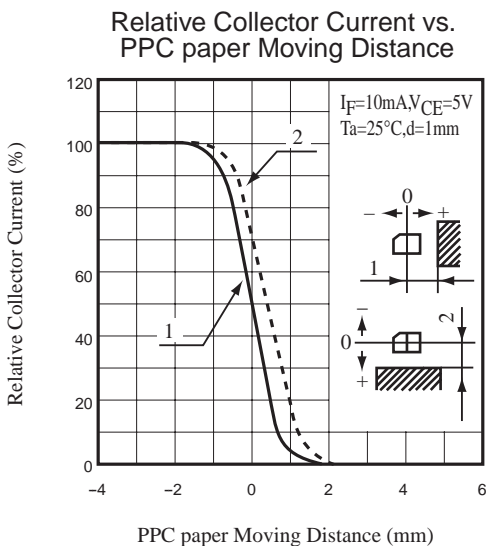
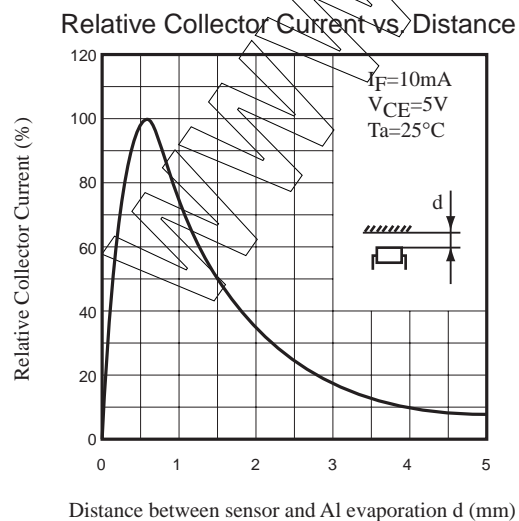
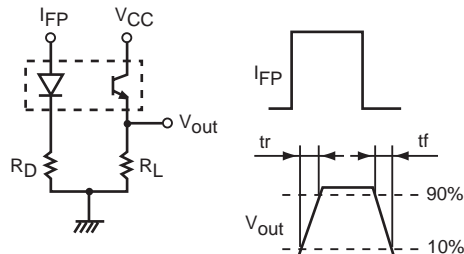
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Test Circuit for Response Time



CAUTION

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Precautionary instructions in handling gallium arsenic products

Special precautions must be taken in handling this product because it contains, gallium arsenic, which is designated as a toxic substance by law. Be sure to adhere strictly to all applicable laws and regulations enacted for this substance, particularly when it comes to disposal.

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